

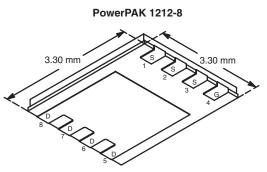
RoHS

COMPLIANT

Vishay Siliconix

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 20	0.019 at V _{GS} = - 4.5 V	- 16 ^e	16.2 nC		
	0.031 at V _{GS} = - 2.5 V	- 16 ^e	10.2 110		



Bottom View

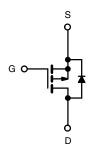
Ordering Information: Si7601DN-T1-E3 (Lead (Pb)-free) Si7601DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFET
- Low Thermal Resistance PowerPAK[®] Package with Small Size and Low 1.07 mm Profile
- PWM Optimized
- 100 % R_a and UIS Tested

APPLICATIONS

- DC/DC Buck Converter
- High-Side Application for Asynchronous Buck



P-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 20	v	
Gate-Source Voltage		V _{GS}	± 12	v
	T _C = 25 °C		- 16 ^e	
	T _C = 70 °C		- 16 ^e	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	- 11.5 ^{a, b}	
	T _A = 70 °C		- 9.2 ^{a, b}	•
Pulsed Drain Current		I _{DM}	- 40	A
Cartinuaus Courses Dusis Diado Current	T _C = 25 °C		- 16 ^e	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 3.15 ^{a, b}	
Avalanche Current			15	
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	11.25	mJ
	T _C = 25 °C		52	
	T _C = 70 °C		33	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.8 ^{a, b}	
	T _A = 70 °C		2.4 ^{a, b}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 50 to 150	
Soldering Recommendations (Peak Temperature) ^{c, d}		ž	260	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. See Solder Profile (http://www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

e. Package limited.

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THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	26	33	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.
b. Maximum under Steady State conditins is 81 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		•		•	•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 11		- 16.8			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = - 250 μΑ		2.63		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.6		- 1.6	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 V, V_{GS} = 0 V$			- 1		
		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 V$, $V_{GS} = -4.5 V$	- 40			А	
Drain-Source On-State Resistance ^a	P	V _{GS} = - 4.5 V, I _D = - 11 A	0.016 0.01		0.0192		
	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 8.9 A		0.025	0.0313	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 11 A		31.7		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1870		pF	
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		490			
Reverse Transfer Capacitance	C _{rss}			460			
Tatal Cata Charge		$V_{DS} = -10 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -11 \text{ A}$	18 27		27		
Total Gate Charge	Qg			16.2	25	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -11 \text{ A}$		4.1			
Gate-Drain Charge	Q _{gd}			4.8			
Gate Resistance	R _g	f = 1 MHz		6.1	9.2	Ω	
Turn-On Delay Time	t _{d(on)}			18	27		
Rise Time	t _r	V_{DD} = - 10 V, R _L = 1.09 Ω		112	168	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 9.2 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		53	80		
Fall Time	t _f			80	120		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 16		
Pulse Diode Forward Current ^a	I _{SM}				- 40	A	
Body Diode Voltage	V _{SD}	I _S = - 6 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			42	63	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			25.2	38	nC	
Reverse Recovery Fall Time	t _a	I _F = - 5 A, dl/dt = 100 A/μs, T _J = 25 °C		14		ns	
Reverse Recovery Rise Time	t _b	1		28			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

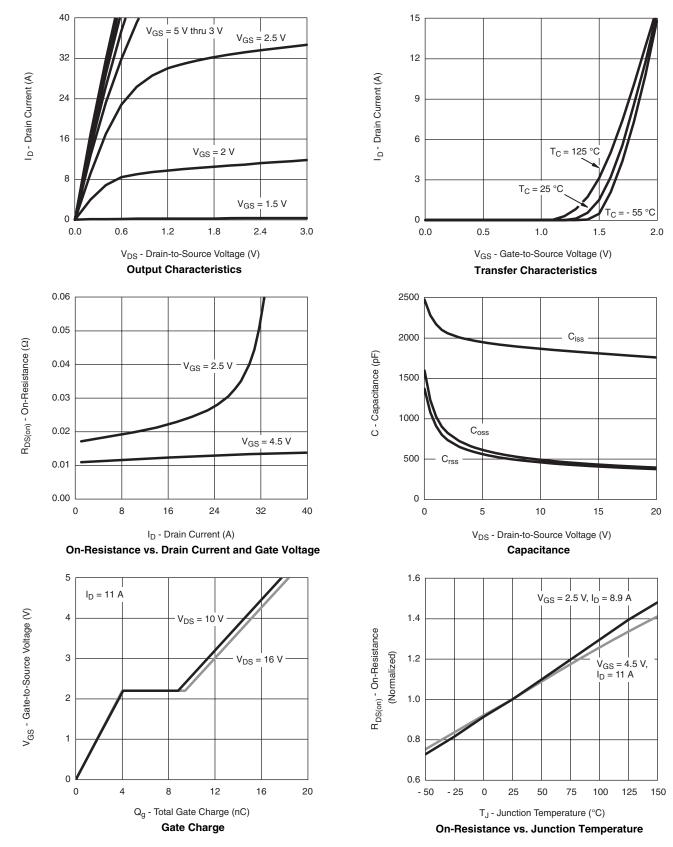
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





Si7601DN Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

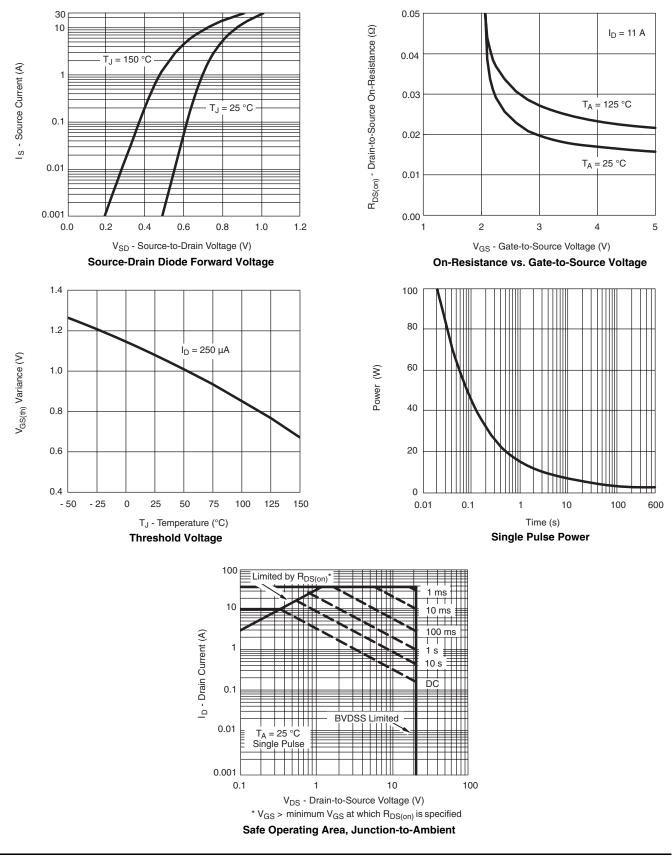


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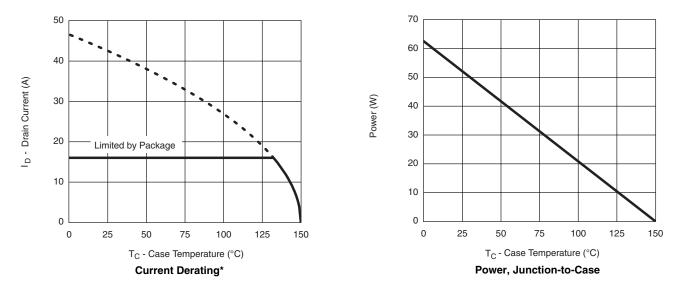
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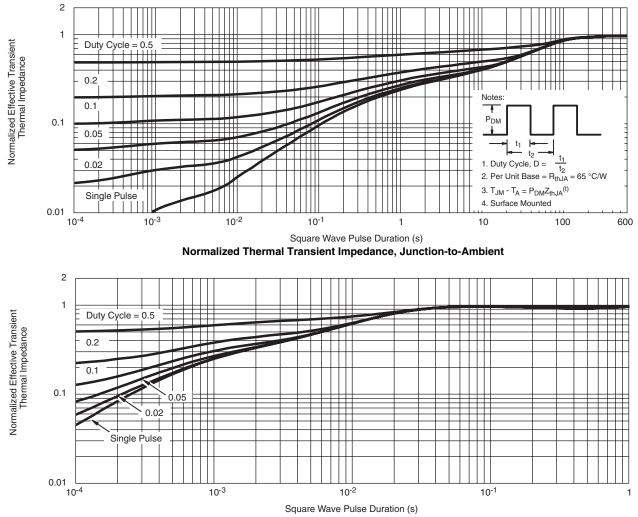


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73778.



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